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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.		
10/709,334	04/29/2004	Hsuan Tso	13031-US-PA	3333		
31561	7590 11/17/2004		EXAM	EXAMINER		
JIANQ CHYUN INTELLECTUAL PROPERTY OFFICE 7 FLOOR-1, NO. 100			WILSON, SCOTT R			
	Γ ROAD, SECTION 2	ART UNIT	PAPER NUMBER			
TAIPEI, 100			2826			
TAIWAN			DATE MAILED: 11/17/2004	1		

Please find below and/or attached an Office communication concerning this application or proceeding.

		Applicati	on No.	Applicant(s)				
		10/709,3	34	TSO, HSUAN				
Office Action Summary		Examine	r	Art Unit				
		Scott R. V	Vilson	2826				
	The MAILING DATE of this communic	cation appears on th	e cover sheet wit	th the correspondence ac	Idress			
THE - Exte after - If the - If NO - Failu Any	ORTENED STATUTORY PERIOD FO MAILING DATE OF THIS COMMUNIC nsions of time may be available under the provisions of SIX (6) MONTHS from the mailing date of this commuse period for reply specified above is less than thirty (30) period for reply is specified above, the maximum stature to reply within the set or extended period for reply reply received by the Office later than three months afted patent term adjustment. See 37 CFR 1.704(b).	CATION. If 37 CFR 1.136(a). In no evinication. If 37 days, a reply within the start within the says the apply and will, by statute, cause the apply and will.	vent, however, may a re tutory minimum of thirty vill expire SIX (6) MONT plication to become ABA	pply be timely filed (30) days will be considered timel (HS from the mailing date of this candoned to the ca	ly. communication.			
1)⊠	Responsive to communication(s) filed	on <u>10 October 200</u>	<u>)4</u> .					
2a) <u></u> ☐								
3)□	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.							
Disposit	ion of Claims							
5)□ 6)⊠ 7)⊠ 8)□ Applicat 9)□	Claim(s) 1-24 is/are pending in the ap 4a) Of the above claim(s) is/are Claim(s) is/are allowed. Claim(s) 1,10,14,15,17,18,20 and 21 Claim(s) 2-9,11-13,16,19 and 22-24 is Claim(s) are subject to restrict ion Papers The specification is objected to by the The drawing(s) filed on 29 April 2004 Applicant may not request that any objection is above the content of the drawing of the content of the drawing(s) filed on 29 April 2004	e withdrawn from considering is/are rejected. s/are objected to. ion and/or election reference. Examiner. is/are: a) accepted	requirement. ed or b)□ objec					
11)	Replacement drawing sheet(s) including The oath or declaration is objected to	•						
Priority (under 35 U.S.C. § 119							
a)	Acknowledgment is made of a claim for All b) Some * c) None of: 1. Certified copies of the priority of Nones of: 2. Certified copies of the priority of Nones of the priority of Nones of the certified copies of the attached detailed Office actions	locuments have bee locuments have bee of the priority docum nal Bureau (PCT Ru	en received. en received in Ap ents have been le 17.2(a)).	oplication No received in this National	Stage			
2) Notice 3) Infor	nt(s) Dee of References Cited (PTO-892) Dee of Draftsperson's Patent Drawing Review (PT The mation Disclosure Statement(s) (PTO-1449 or Fer No(s)/Mail Date 4/29/04.		Paper No(s	ummary (PTO-413))/Mail Date formal Patent Application (PT ·	O-152)			

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DETAILED ACTION

Election/Restrictions

Applicant's election without traverse of claims 1-24, and cancellation of claims 25-45 in the response filed 10 October 2004 is acknowledged.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 1, 10, 14, 17, 20 and 21 are rejected under 35 U.S.C. 102(b) as being anticipated by Rodov et al.. As to claim 1, Rodov et al., Figure 2, discloses a superjunction Schottky device (Abstract) comprising a back metal layer (12), a semiconductor substrate of a first conductivity type (14) on the back metal layer, a plurality of superjunction cells (18) on the semiconductor substrate, including a plurality of charge-balance layers that extend substantially vertically (18), a lightly-doped junction barrier Schottky (JBS) region (16) of the first conductivity type on each superjunction cell, and a front conductor layer (10) over the substrate, contacting with the JBS region to form a Schottky contact with the JBS region (paragraph 0014).

As to claim 10, Rodov et al., Figure 2, discloses that the superjunction cells are arranged adjacent to each other.

As to claim 14, Rodov et al., Figure 2, discloses that each superjunction cell is formed from alternating stripes of n and p doped regions (paragraph 0013). This structure may include a first layer of a second conductivity type, a second layer of the first conductivity type, and a third layer of the second conductivity type arranged in sequence.

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As to claim 17, Rodov et al., Figure 2, discloses that the JBS region comprises a lightly doped region of the first conductivity type (16) over all superjunction cells.

As to claim 20, Rodov et al., paragraph (0015) and Figure 3A, discloses that the superjunction cells (18) are located in an epitaxial silicon layer (30).

As to claim 21, Rodov et al., paragraph (0014) and Figure 2, discloses that the front conductor layer (10) comprises a metal layer forming the Schottky contact with the JBS region.

Claims 1, 10, 14, 15, 17, 18 and 21 are rejected under 35 U.S.C. 102(b) as being anticipated by Baliga. As to claim 1, Baliga, Figure 5, discloses a superjunction Schottky device comprising a back metal layer (11b), a semiconductor substrate (13) of a first conductivity type on the back metal layer, a plurality of superjunction cells on the semiconductor substrate, one of which is shown illustrated, including a plurality of charge balance layers (14a), (14b), (12) that extend substantially vertically, a lightly doped junction barrier Schottky (JBS) region (22) of the first conductivity type on each superjunction cell, and a front conductor (16) layer over the substrate, contacting with the JBS region to form a Schottky contact with the JBS region.

As to claim 10, Baliga, Figure 5, discloses that the superjunction cells, one of which is shown illustrated, are arranged adjacent to each other.

As to claim 14, Baliga, Figure 5, discloses that each superjunction cell comprises a first layer of a second conductivity type (14a), a second layer of the first conductivity type (12), and a third layer of the second conductivity type (14b) arranged in sequence.

As to claim 15, Baliga, Figure 5, discloses a guard ring (24a), (24b) of the second conductivity type at the periphery of the Schottky contact above the superjunction cell.

As to claim 17, Baliga, Figure 5, discloses that the JBS region (22) comprises a lightly doped region of the first conductivity type over all superjunction cells, one of which is shown in the figure.

As to claim 18, Baliga, in the Abstract, discloses that the doping concentration in the superjunction cell is about 1×10^{17} cm⁻³.

As to claim 21, Baliga, (col. 7, lines 30-32), discloses that the front conductor layer (16) comprises a metal layer forming the Schottky contact with the JBS region.

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Allowable Subject Matter

Claims 2-9, 11-13, 16, 19 and 22-24 objected to as being dependent upon a rejected base claim,

but would be allowable if rewritten in independent form including all of the limitations of the base claim

and any intervening claims.

Any inquiry concerning this communication or earlier communications from the examiner should

be directed to Scott R. Wilson whose telephone number is 571-272-1925. The examiner can normally be

reached on M-F 8:30 - 4:30 Eastern.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor,

Nathan Flynn can be reached on 571-272-1915. The fax phone number for the organization where this

application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application

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srw

November 8, 2004

SUPERVISORY PATENT EXAMINER

TECHNOLOGY CENTER 2800